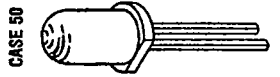
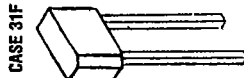
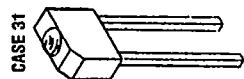
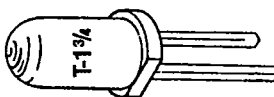


VTT PHOTOTRANSISTORS

PRODUCT PACKAGE

CASE 26



LONG T-1

RECESSED LENS
LATERAL

FLAT OVAL

MINI FLAT

MINI LENS

ELECTRO-OPTICAL CHARACTERISTICS (at 25°C)

PART NO.	CHIP TYPE	Light ⁽¹⁾ Current		Dark Current		Collector Breakdown V _{CE(sat)} I _C =100 μA H=0	Emitter Breakdown V _{BE(sat)} I _E =100 μA H=0	Saturation Voltage V _{CE(sat)} I _C =1.0 mA R _θ =100	Rise/Fall Time t _r , t _f	Ang. ⁽²⁾ Resp. θ	CASE ⁽³⁾ STYLE	CASE NO.
		I _C		I _C								
		Condition		H=0								
		mA	μA	V _{CE} f.c.	V _{CE} max/Volts							
PHOTOTRANSISTOR												
VT11012	50T	0.2	0.6	100	50	25	20	50	60	0.40	3	1
VT11014		0.4	1.2	100	50	25	20	40	60	0.40	5	
VT11010		1.0	3.0	100	50	25	20	30	40	0.40	5	
VT11013		2.5	10.0	100	50	25	10	20	40	0.40	8	
VT11020	25T	0.75	0.20	100	50	10	20	50	60	0.25	1.5	2
VT11021		0.15	0.35	100	50	10	20	50	60	0.25	2	
VT11022		0.30	0.75	100	50	10	20	40	60	0.25	3	
VT11023		0.60	—	100	50	100	10	30	40	0.25	4	
VT11031	60T	1.0	—	100	50	100	10	40	50	0.40	5	2
VT11032		4.0	—	100	50	100	10	40	50	0.40	10	
VT11033		8.0	—	100	50	100	10	40	50	0.40	15	
VT11110	50T	1.0	3.0	100	50	25	20	50	60	0.40	3	
VT11111		2.0	6.0	100	50	25	20	40	60	0.40	5	
VT11112		8.0	10.0	100	50	25	10	30	40	0.40	5	
VT11113		15.0	—	100	50	100	10	20	40	0.40	8	
VT11120	25T	0.35	0.75	100	50	10	20	50	60	0.25	1.5	3
VT11121		0.65	1.50	100	50	10	20	50	60	0.25	2	
VT11122		1.25	3.50	100	50	10	20	40	60	0.25	3	
VT11123		3.0	—	100	50	100	10	30	40	0.25	4	
VT11131	60T	1.0	—	20	50	100	10	40	50	0.40	5	3
VT11132		4.0	—	20	50	100	10	40	50	0.40	10	
VT11133		8.0	—	20	50	100	10	40	50	0.40	15	
VT11211	40T	1.3	—	20	50	100	10	30	50	0.25	3	
VT11212		2.0	—	20	50	100	10	30	50	0.25	4	
VT11213		2.7	—	20	50	100	10	30	50	0.25	5	
VT11214		4.0	—	20	50	100	10	30	50	0.25	6	
VT11221	25T	4.0	—	100	50	100	10	30	60	0.25	1.5	26
VT11222		8.0	—	100	50	100	10	30	50	0.25	2	
VT11223		12.0	—	100	50	100	10	30	50	0.25	3	
VT11224		15.0	—	100	50	100	10	30	50	0.25	4	
VT11231W	25T	0.1	—	100	50	100	10	30	50	0.25	1.5	26
VT11232W		0.3	—	100	50	100	10	30	50	0.25	2	
VT11233W		0.6	—	100	50	100	10	30	50	0.25	3	
VT11234W		1.5	—	100	50	100	10	30	50	0.25	4	

VTT PHOTOTRANSISTORS

ELECTRO-OPTICAL CHARACTERISTICS (at 25°C)

PART NO. CHIP TYPE	Light ⁽¹⁾ Current		Dark Current	Collector Breakdown Voltage	Emitter Breakdown Voltage	Saturation Voltage	Rise/Fall Time	Ang. Resp.	CASE ⁽³⁾ STYLE	CASE NO.
	Condition									
	mA	h								
	min	max								
PHOTOTRANSISTOR										
VT13821	0.03	20	50	100	10	30	5.0	0.25	1.5	31
VT13822	0.08	20	50	100	10	30	5.0	0.25	2	
VT13823	0.12	20	50	100	10	30	5.0	0.25	3	
VT13825	0.72	20	50	100	10	30	5.0	0.25	4	
VT13821F	0.08	20	50	100	10	30	5.0	0.25	1.5	31F
VT13822F	0.12	20	50	100	10	30	5.0	0.25	2	
VT13823F	0.24	20	50	100	10	30	5.0	0.25	3	
VT13721	0.05	20	50	100	10	30	5.0	0.25	1.5	
VT13722	0.10	20	50	100	10	30	5.0	0.25	2	48
VT13723	0.20	20	50	100	10	30	5.0	0.25	3	
VT13821	0.03	20	50	100	10	30	5.0	0.25	1.5	
VT13822	0.06	20	50	100	10	30	5.0	0.25	2	
VT13823	0.12	20	50	100	10	30	5.0	0.25	3	7
VT17111	0.5	100	50	100	10	30	5.0	0.40	3	
VT17112	1.0	100	50	100	10	30	5.0	0.40	4	
VT17113	3.5	100	50	100	10	30	5.0	0.40	5	
VT17114	6.0	100	50	100	10	30	5.0	0.40	6	31F
VT17121	0.5	100	50	100	10	30	5.0	0.25	1.5	
VT17122	1.0	100	50	100	10	30	5.0	0.25	2	
VT17123	2.0	100	50	100	10	30	5.0	0.25	3	
VT17124	3.0	100	50	100	10	30	5.0	0.25	4	49
VT17125	4.5	100	50	100	10	30	5.0	0.25	5	
VT17231	0.25	100	50	100	10	30	5.0	0.25	1	
VT17232	0.50	100	50	100	10	30	5.0	0.25	2	
VT17223	1.0	100	50	100	10	30	5.0	0.25	3	31F
VT17224	1.5	100	50	100	10	30	5.0	0.25	4	
VT17225	2.25	100	50	100	10	30	5.0	0.25	5	
VT17311	0.5	100	50	100	10	30	5.0	0.40	3	
VT17312	1.0	100	50	100	10	30	5.0	0.40	4	49
VT17313	3.5	100	50	100	10	30	5.0	0.40	5	
VT17314	6.0	100	50	100	10	30	5.0	0.40	6	
VT17321	0.5	100	50	100	10	30	5.0	0.25	1.5	
VT17322	1.0	100	50	100	10	30	5.0	0.25	2	8
VT17323	2.0	100	50	100	10	30	5.0	0.25	3	
VT17324	3.0	100	50	100	10	30	5.0	0.25	4	
VT17325	4.5	100	50	100	10	30	5.0	0.25	5	
VT17421	0.3	100	50	100	10	30	5.0	0.25	1	9
VT17422	0.6	100	50	100	10	30	5.0	0.25	2	
VT17423	1.2	100	50	100	10	30	5.0	0.25	3	
VT17424	1.8	100	50	100	10	30	5.0	0.25	4	
VT17425	2.7	100	50	100	10	30	5.0	0.25	5	10
VT19011	0.5	30	100	50	100	5	30	0.55	2	
VT19012	2.0	60	100	50	100	5	30	0.55	4	
VT19013	5.0	100	50	100	5	30	60	0.55	10	
VT19111	2.0	80	100	50	100	5	30	0.55	2	9
VT19112	6.0	180	100	50	100	5	30	0.55	4	
VT19113	14.0	100	50	100	5	30	40	0.55	8	
VT19310	0.7	100	50	100	5	30	60	0.40	3	
VT19311	0.4	100	50	100	5	30	60	0.40	5	10
VT19312	0.25	100	50	100	5	30	60	0.40	5	
VT19313	2.5	100	50	100	5	30	60	0.40	8	
VT19320	0.75	20	100	50	10	20	50	0.25	1	
VT19321	0.15	100	50	100	5	30	60	0.25	2	10
VT19322	0.30	75	100	50	10	20	40	0.25	3	
VT19323	0.60	100	50	100	5	30	40	0.25	4	
VT19324	1.20	100	50	100	5	30	40	0.25	5	

*RT - INFRARED TRANSMITTING

EG&G VACTEC

VTT PHOTOTRANSISTORS

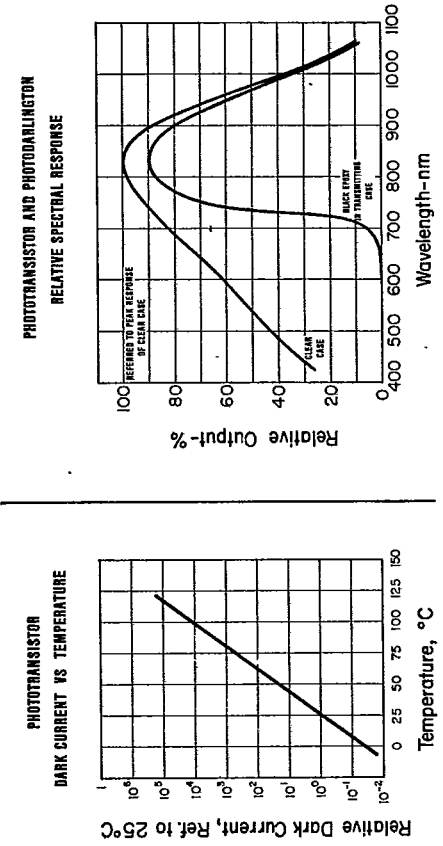
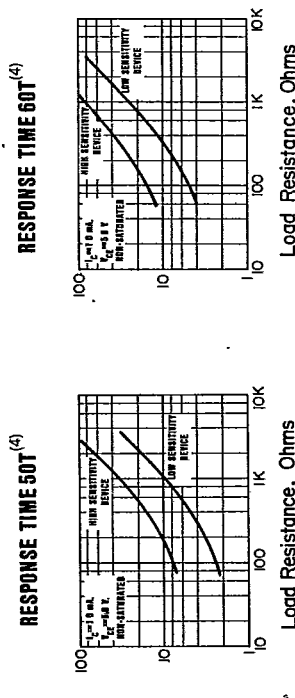
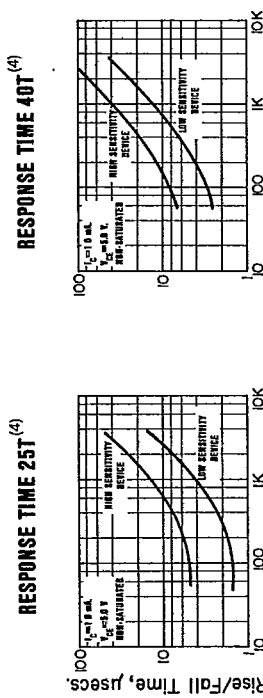
ELECTRO-OPTICAL CHARACTERISTICS (at 25°C)

PART NO. CHIP TYPE	Light ⁽¹⁾ Current		Dark Current	Collector Breakdown Voltage	Emitter Breakdown Voltage	Saturation Voltage	Rise/Fall Time	Ang. Resp.	CASE STYLE	CASE NO.
	Condition									
	mA	V _{CE} H								
	min	max								
PHOTOTRANSISTOR										
VT1311	0.8	20	50	100	10	30	5.0	0.25	3	26
VT1312	1.2	20	50	100	10	30	5.0	0.25	4	
VT1313	1.6	20	50	100	10	30	5.0	0.25	5	
VT1314	2.4	20	50	100	10	30	5.0	0.25	6	
VT1321	2.0	100	50	100	10	30	5.0	0.25	1.5	
VT1322	4.0	100	50	100	10	30	5.0	0.25	2	26
VT1323	6.0	100	50	100	10	30	5.0	0.25	3	
VT1324	8.0	100	50	100	10	30	5.0	0.25	4	
VT1321W	0.06	100	50	100	10	30	5.0	0.25	1.5	26
VT1322W	0.50	100	50	100	10	30	5.0	0.25	2	
VT1323W	0.90	100	50	100	10	30	5.0	0.25	3	
VT13121	0.5	15	100	50	10	20	50	0.25	1.5	4
VT13122	1.2	50	100	50	10	20	40	0.25	2.5	
VT13123	4.0	100	50	100	10	30	40	0.25	4	
VT13121E	0.5	15	100	50	10	20	50	0.25	1.5	- 5
VT13122E	1.2	50	100	50	10	20	40	0.25	2.5	
VT13123E	4.0	100	50	100	10	30	40	0.25	4	
VT13321	1.0	100	50	100	10	30	5.0	0.25	1.5	6
VT13322	2.0	100	50	100	10	30	5.0	0.25	2	
VT13323	4.0	100	50	100	10	30	5.0	0.25	3	
VT13324	6.0	100	50	100	10	30	5.0	0.25	4	
VT13325	9.0	100	50	100	10	30	5.0	0.25	5	
VT13321A	0.5	100	50	100	10	30	5.0	0.25	1.5	6A
VT13322A	1.0	100	50	100	10	30	5.0	0.25	2	
VT13323A	2.0	100	50	100	10	30	5.0	0.25	3	
VT13324A	4.0	100	50	100	10	30	5.0	0.25	4	
VT13325A	6.0	100	50	100	10	30	5.0	0.25	5	
VT13321L	0.5	20	50	100	10	30	5.0	0.25	1.5	50
VT13322L	1.0	20	50	100	10	30	5.0	0.25	2	
VT13323L	2.0	20	50	100	10	30	5.0	0.25	3	
VT13324L	4.0	20	50	100	10	30	5.0	0.25	4	
VT13325L	6.0	20	50	100	10	30	5.0	0.25	5	
VT13321LA	0.5	20	50	100	10	30	5.0	0.25	1.5	50A
VT13322LA	1.0	20	50	100	10	30	5.0	0.25	2	
VT13323LA	2.0	20	50	100	10	30	5.0	0.25	3	
VT13324LA	4.0	20	50	100	10	30	5.0	0.25	4	
VT13325LA	6.0	20	50	100	10	30	5.0	0.25	5	
VT13421	0.6	100	50	100	10	30	5.0	0.25	1.5	6
VT13422	1.2	100	50	100	10	30	5.0	0.25	2	
VT13423	2.4	100	50	100	10	30	5.0	0.25	3	
VT13424	3.6	100	50	100	10	30	5.0	0.25	4	
VT13425	5.4	100	50	100	10	30	5.0	0.25	5	
VT13421A	0.6	100	50	100	10	30	5.0	0.25	1.5	6A
VT13422A	1.2	100	50	100	10	30	5.0	0.25	2	
VT13423A	2.4	100	50	100	10	30	5.0	0.25	3	
VT13424A	3.6	100	50	100	10	30	5.0	0.25	4	
VT13425A	5.4	100	50	100	10	30	5.0	0.25	5	
VT13421L	0.3	20	50	100	10	30	5.0	0.25	1.5	50
VT13422L	0.6	20	50	100	10	30	5.0	0.25	2	
VT13423L	1.2	20	50	100	10	30	5.0	0.25	3	
VT13424L	2.4	20	50	100	10	30	5.0	0.25	4	
VT13425L	3.6	20	50	100	10	30	5.0	0.25	5	
VT13421LA	0.3	20	50	100	10	30	5.0	0.25	1.5	50A
VT13422LA	0.6	20	50	100	10	30	5.0	0.25	2	
VT13423LA	1.2	20	50	100	10	30	5.0	0.25	3	
VT13424LA	2.4	20	50	100	10	30	5.0	0.25	4	
VT13425LA	3.6	20	50	100	10	30	5.0	0.25	5	
VT13521	0.05	20	50	100	10	30	5.0	0.25	1.5	31
VT13522	0.15	20	50	100	10	30	5.0	0.25	2	
VT13523	0.30	20	50	100	10	30	5.0	0.25	3	
VT13524	0.45	20	50	100	10	30	5.0	0.25	4	
VT13525	0.70	20	50	100	10	30	5.0	0.25	5	
VT13521E	0.10	20	50	100	10	30	5.0	0.25	1.5	31F
VT13522E	0.20	20	50	100	10	30	5.0	0.25	2	
VT13523E	0.40	20	50	100	10	30	5.0	0.25	3	

*RT - INFRARED TRANSMITTING

VTT PHOTOTRANSISTORS

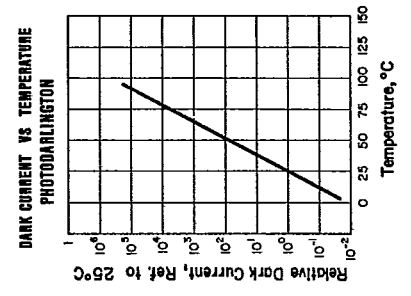
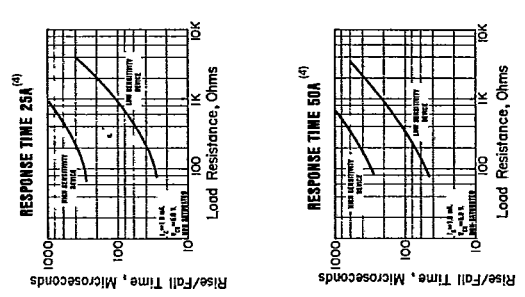
ELECTRO-OPTICAL CHARACTERISTICS (at 25°C)



VTA PHOTODARLINGTONS

ELECTRO-OPTICAL CHARACTERISTICS (at 25°C)

PART NO.	CHIP TYPE	Light ⁽¹⁾ Current		Dark Current	Collector Breakdown	Emitter Breakdown	Saturation Voltage	Rise/Fall Time	Ang. Resp.	CASE ⁽²⁾ STYLE	CASE NO.
		mA									
		Condition									
		I _c	I _e								
PHOTODARLINGTON											
VTA1011	50A	1	4	50	100	10	60	15	60	TO-18 FLAT WINDOW	1
VTA1012	50A	3	10	40	50	500	10	30	120		
VTA1013	50A	8	40	50	1000	10	40	60	250		
VTA1021	25A	0.25	1.0	40	50	200	10	50	30	TO-18 LENS	3
VTA1022	25A	0.75	2.5	40	50	200	10	40	60		
VTA1023	25A	2.0	4.0	50	500	10	30	60	150		
VTA1111	50A	15	20	40	50	100	10	40	60	TO-18 LENS	5
VTA1112	50A	40	50	100	10	30	60	15	100		
VTA1113	50A	100	50	100	10	30	60	15	250		
VTA1121	25A	1	5	40	50	100	10	40	60	TO-18 LENS	7
VTA1122	25A	3	10	40	50	100	10	30	120		
VTA1123	25A	8	40	50	1000	10	40	60	250		
VTA121E	25A	10	50	40	50	100	10	40	60	TO-18 LENS	9
VTA122E	25A	30	40	50	100	10	30	60	150		
VTA123E	25A	100	50	50	100	10	30	60	150		
VTA321E	25A	10	50	40	50	100	10	40	60	TO-18 LENS	11
VTA322E	25A	30	40	50	100	10	30	60	150		
VTA323E	25A	100	50	50	100	10	30	60	150		
VTA7121	25A	0.4	4.0	50	100	10	30	60	15	TO-18 LENS	13
VTA7122	25A	0.8	4.0	50	100	10	30	60	15		
VTA7123	25A	1.6	4.0	50	200	10	30	60	15		
VTA9311	50A	1	40	50	100	10	50	60	15	TO-18 LENS	15
VTA9312	50A	3	100	40	50	1000	10	40	120		
VTA9313	50A	8	40	50	1000	10	30	60	250		
VTA9321	25A	0.25	1.0	40	50	100	10	50	30	TO-18 LENS	17
VTA9322	25A	0.75	2.5	40	50	200	10	40	60		
VTA9323	25A	2.0	4.0	50	200	10	30	60	150		



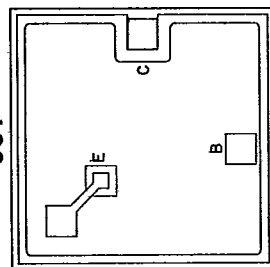
VTA-C/VTT-C CHIPS

ELECTRO-OPTICAL CHARACTERISTICS (at 25°C)

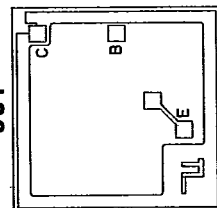
PART NO		D.C. Current Gain		Dark Current	Collector Breakdown Voltage	Emitter Breakdown Voltage	Saturation Voltage	Rise/Fall Time	Collector-Base Sensitivity
Beta		Test Condition		H=0 V _{CE} =10V I _B =0 nA, max	V _{RECO} I _C =100 µA Volts min	V _{RECO} I _E =100 µA Volts min	V _{CE(SAT)} I _C =1.0 mA I _E =50 µA	t _r , t _f µsec typ	S _{RCBO} (typ) V _{CE} =5.0 V
CHIP TYPE	min	typ	µA	Vce Volts	Volts min	Volts min	Volts max		nA/(µW/cm²)
CHIPS									
VTA-C25	25A	10K	50K	0.02 5.0	200	30 5.0	1.5	100	8 0.5
VTA-C50	50A	5K	35K	0.24 5.0	100	30 5.0	1.5	150	83 3.0
VTT-C25	25T	250	500	1.3 5.0	100	30 5.0	0.25	3	14 0.8
VTT-C40	40T	150	550	4.0 5.0	100	30 5.0	0.4	4	35 2.7
VTT-C50	50T	200	350	6.0 5.0	100	30 5.0	0.4	5	70 6.0
VTT-C60	60T	200	500	10.0 5.0	100	40 5.0	0.4	8	17 6.6

PHOTOTRANSISTOR mm (inch)

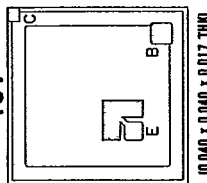
60T



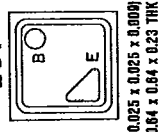
50T



40T

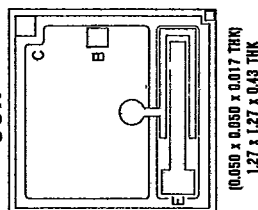


25T

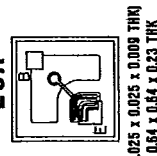


PHOTODARLINGTON

50A



25A



VTM MATCHED SETS

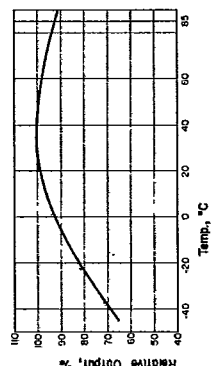
ELECTRO-OPTICAL CHARACTERISTICS (at 25°C)

PART NO.	Light Current		Dark ⁽⁷⁾ Current	Collector ⁽⁷⁾ Breakdown Voltage	Emitter ⁽⁷⁾ Breakdown Voltage	Saturation Voltage	Rise/Fall Time	LED Forward Voltage	OUTPUT DEVICE				
	I _c	Condition	I _{CO} = 10V	V _{RECOB}	V _{RECOB}	V _{CE(SAT)}	t _r , t _f	V _F					
			V _{CE} = 100 V	I _C = 100 μA	I _E = 100 μA	Cond	R _r	I _E = 20 mA					
			mA, min./max.	V _{CE} = 100 V, min./max.	Volts, min./max.	Volts, min./max.	μsec/typ	mA, min./max.					
MATCHED LED - PHOTOTRANSISTOR / LED - PHOTODARLINGTON													
VTM 3321	10	20	50	6.5	100	30	50	0.4	0.25	20	3	16	PHOTOTRANSISTOR
VTM 3322	30	20	50	9.5	100	30	50	0.4	0.25	20	50	16	PHOTODARLINGTON
VTM 3323	50	20	50	30	100	30	50	0.4	0.25	20	50	16	PHOTODARLINGTON
VTM 7121	0.5	20	50	30	100	30	50	0.4	0.25	20	3	16	PHOTODARLINGTON
VTM 7122	1.0	20	50	30	100	30	50	0.4	0.25	20	4	16	PHOTODARLINGTON
VTM 7123	1.0	20	50	30	100	30	50	0.4	0.25	20	3	16	PHOTODARLINGTON
VTM 7124	2.0	20	50	30	100	30	50	0.6	1.8	20	7	16	PHOTODARLINGTON
VTM 7125	0.5	20	50	30	100	30	50	1.0	0.25	20	50	16	PHOTODARLINGTON

Each matched set consists of a discrete GaAs infrared emitting diode (RED) and a discrete silicon phototransistor (photodarlington).

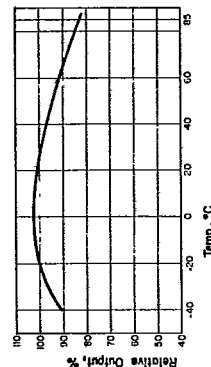
LED/PHOTODARLINGTON

OUTPUT CURRENT VS. TEMPERATURE

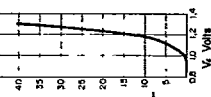


LED/PHOTOTRANSISTOR

OUTPUT CURRENT VS. TEMPERATURE

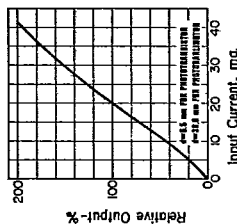


LED FWD VOLTAGE DROP



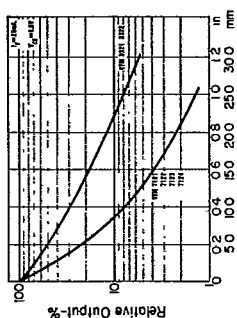
LED/PHOTODARLINGTON

RELATIVE OUTPUT VS. INPUT CURRENT



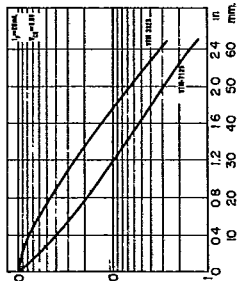
LED/PHOTOTRANSISTOR

RELATIVE OUTPUT VS. DISTANCE



LED/PHOTODARLINGTON

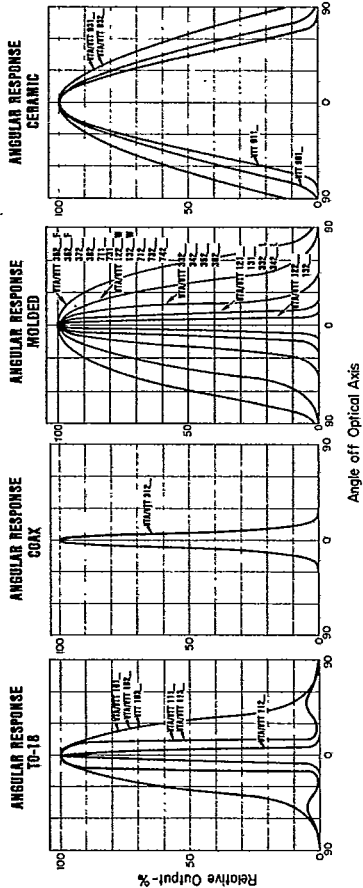
RELATIVE OUTPUT VS. DISTANCE



EG&G VACTEC

EG&G VACTEC

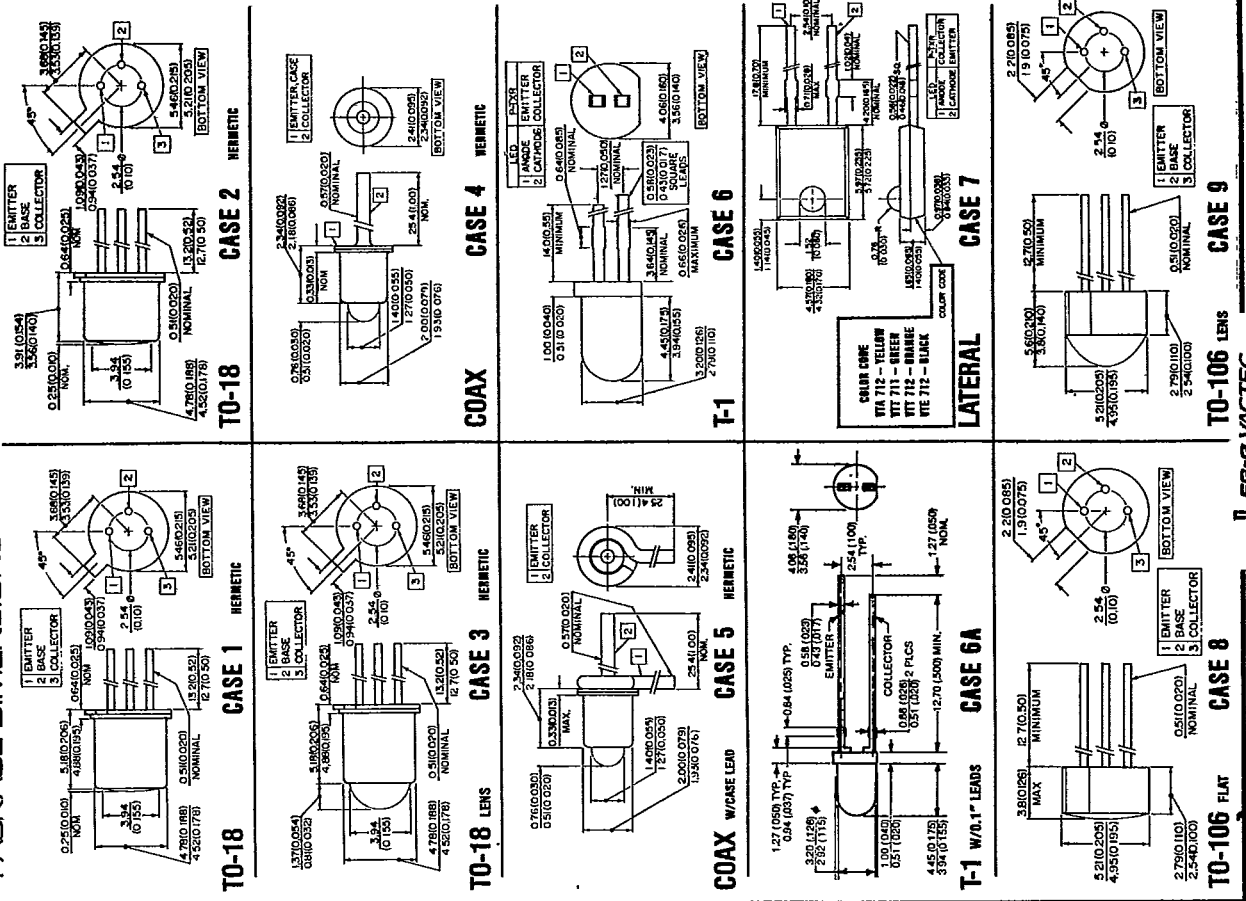
ELECTRO-OPTICAL CHARACTERISTICS (at 25°C)



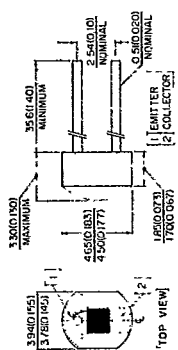
NOTES

1. Light source is a tungsten incandescent lamp operating at 2850 K, 100 fc from this source is a nominal 5mW/cm² (1 mW/cm² = 19.2 fc @ 2850 K).
2. Angular response is the angle between the optical axis and the angle for which the response is 50%.
3. On a 3 terminal device, the base terminal is connected. All specifications are with zero base current (I_B).
4. Response time curves show typical characteristics for devices having the lowest and highest light current in any series. (Example) VTT 1020 (lowest sensitivity) and VTT 1023 (highest sensitivity). Interpolate curves for intermediate sensitivity devices.
5. I_F is LED forward current.
6. d is the lens to lens spacing between the LED and detector.
7. $I_F = 0$.
8. $H=0$ for all chip tests.
9. $I_C = S_{ACO}$ x I_C x B_{ELA} . B_{ELA} is base drive dependent and therefore is a function of light level. At base drive lower than that specified, the B_{ELA} falls off somewhat, and is higher at greater base drives.
10. E, B and C are bond pads for Emitter, Base and Collector. Chips are supplied with nickel or gold over nickel backside for silver epoxy die attach only. The collector connection should be made through the backside.
11. Chips are supplied in bulk form in vials or in chip trays. Quality is verified by a sampling plan. Selected chips from a vial are mounted on a TO-18 header, sealed and tested to the specification.

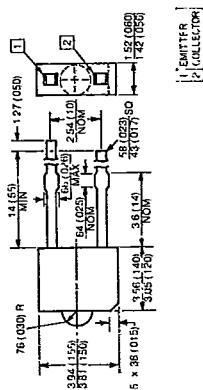
PACKAGE DIMENSIONS (inches)



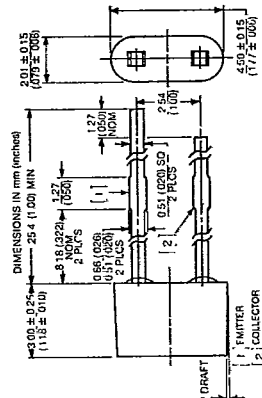
PACKAGE DIMENSIONS



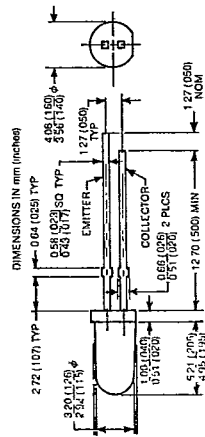
CERAMIC CASE 10



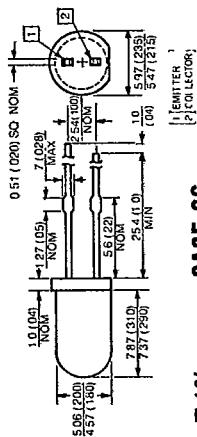
MINI LENS



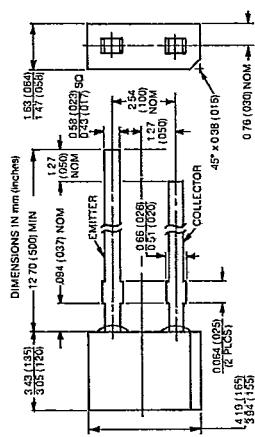
FLAT OVAL



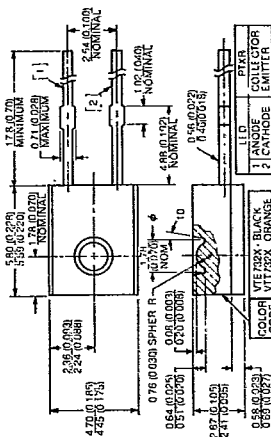
LONG T-1



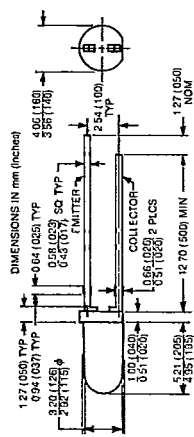
T-13/4



MINI FLAT CASE 31F



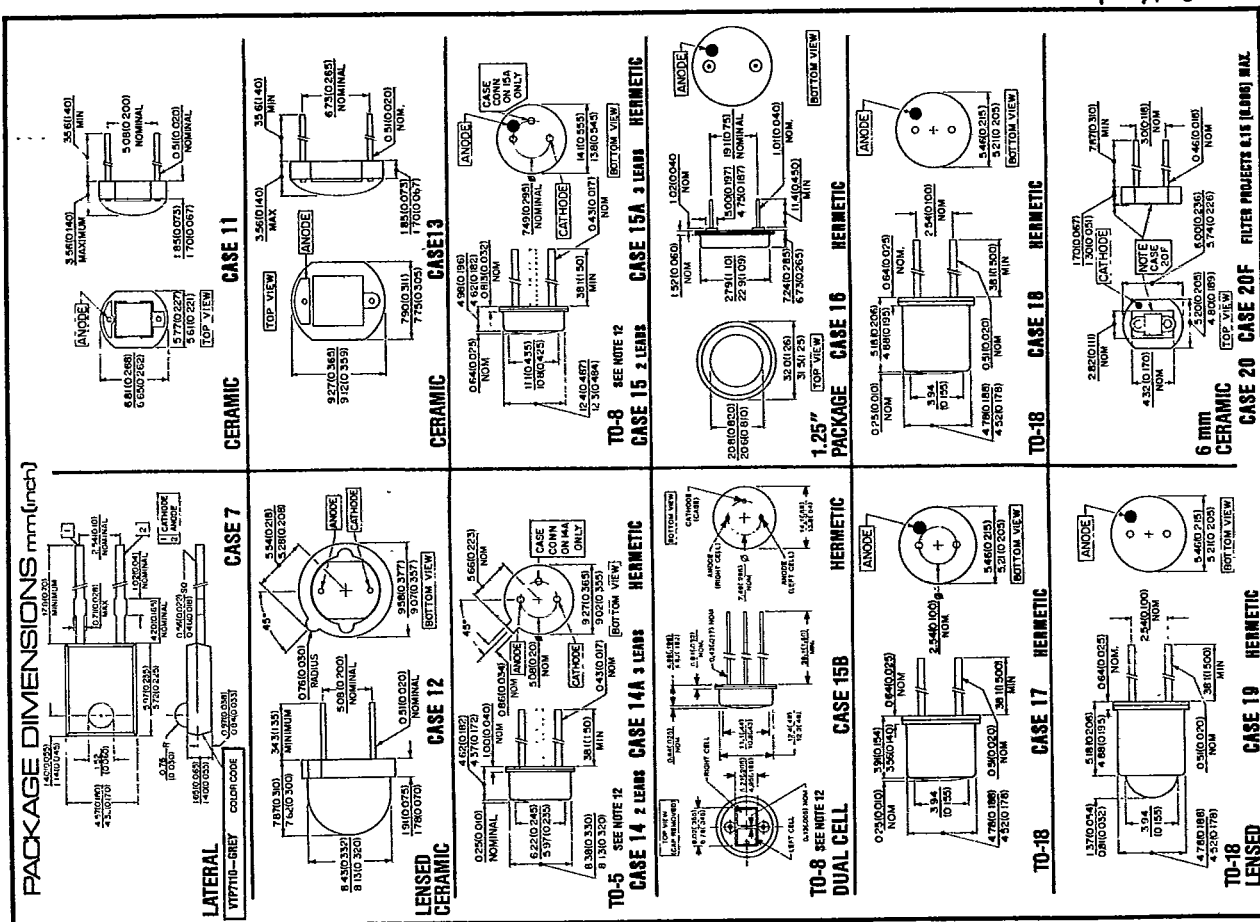
RECESSED CASE 49



LONG T-1

SILICON PHOTODIODES

PREFIX	DESCRIPTION	PAGE
VTB	Blue Enhanced	10, 11
VTP	Fast Response	12
	Large Area	
VTS-1	Solar Process	13
VTS-2	Low Capacitance	14
VTS-3	Super Blue Enhanced	15
	Specification Notes	11
	Application Information	9
	Package Dimensions	7, 8



PACKAGE DIMENSIONS mm (inch)				ANODE (ACTIVE) SURFACE SHOWN		CATHODE IS BACKSIDE	
20 SERIES	30 SERIES	31 SERIES	30 SERIES	31 SERIES	20 SERIES	30 SERIES	31 SERIES
A							
B							
C							
THK							
				CASE 44		CASE 45	

NOTES

[illegible]

APPLICATION INFORMATION

ABSOLUTE MAXIMUM RATINGS

PARAMETER	CASE STYLE					
	HERMETIC		EPOXY		UNMOUNTED	
TEMPERATURE RANGE OPERATING - °C STORAGE - °C	14 14A	11 12 13	7 22	44 45	44 45	44 45
	15 15A	20 20F	50 51	20 SERIES	30 SERIES	30 SERIES
	17 18 19	21 21F	52 52A	31 SERIES	30 SERIES	30 SERIES
LEAD SOLDERING TEMP. (1.6 mm from case, 5 Sec max) °C	-40 + 125	-20 + 75	-40 + 85	-40 + 125	-40 + 105	-40 + 105
	-65 + 150	-40 + 85	-40 + 100	-65 + 150	-40 + 105	-40 + 105
	260	260	230	NOTE (10)	NOTE (10)	NOTE (10)

GENERAL

All silicon diodes are light sensitive. When the junction geometry is such that the light sensitivity is optimized, the device is called a photodiode. Photodiodes may be operated with reverse voltage bias (photoconductive mode) or without (photovoltaic mode). In either case, the current through the diode is proportional to the radiation falling on the junction. Photodiodes which are intended for photovoltaic operation may not have a reverse voltage rating but in all other respects are the same as any other photodiode. Diodes which are used for solar power conversion are called photovoltaic cells because they are always operated in the photovoltaic mode.

Most detector diodes are used in the photovoltaic mode with a short circuit termination. This yields the most linear light to current conversion. Short circuit operation is simply achieved using an operational amplifier with a transimpedance connection. A typical circuit is shown on page 10. Since there is no dark current through the cell, as there is no applied voltage, detection and measurement circuits can be operated on a DC basis avoiding the extra hardware and circuitry required by chopped light sources.

CASE STYLE AND HANDLING PRECAUTION

Diodes presented in this catalogue are mounted in several different types of cases or may be supplied unmounted. A brief description of the case style for each item is given in the tables.

Hermetic cases have glass to metal seals. The chips are mounted directly to the case or may be insulated from the case. The latter allows the metal can to be used as a shield to reduce noise pickup in high gain circuits. Hermetic cases, while quite rugged, must be protected from stresses on the glass seal around the wires and lens.

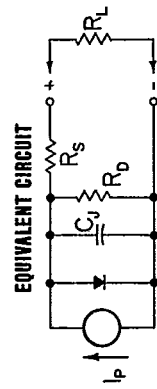


FIGURE 1

Ceramic cases utilize an epoxy overcoating to protect the chip. These are very rugged parts but in some units, the chip is close to the surface.

Epoxy cases may be molded or cast. Scratches on the epoxy will degrade electro-optical characteristics.

Unmounted cells in the VTS1, 2 and 3 series are fragile, especially when the area is large. The front and back electrodes are solder coated and may be soldered using a 60/40 tin-lead solder. The flux should be active so that the joint may be made quickly to minimize heating. Whenever possible, it is recommended that soldering be done at VACTEC since excessive heat may degrade the device parameters. Avoid handling leadless cells with bare fingers since they do not have the protective coating provided on cells with flying leads.

ELECTRO OPTICAL CHARACTERISTICS

The equivalent circuit of a photodiode is shown in Figure 1. It consists of an ideal current generator in parallel with an ideal diode. The junction capacitance, dark resistance and series resistance account for the other diode parameters.

a. Radiometric sensitivity: The current generated depends upon the energy and wavelength of the radiation actually falling on the junction. The Absolute Response curves indicate the amperes generated by a diode for each watt irradiating the junction when the wavelength is known and is independent of the junction area.

b. Quantum efficiency of a diode is related to the radiometric sensitivity by the following formula

$$Q.E. = \frac{124 S_R}{\lambda} \%$$

Where S_R = radiometric sensitivity, amperes per watt
 λ = wavelength, micrometers

The equation relates the energy per photon and the quantum yield, electrons per photon. One hundred percent Q.E. indicates that each photon produces one electron.

c. Responsivity, R_e is the parameter which accounts for chip area and is the output current per unit of irradiance.

$$R_e = \frac{I_p}{E_e} \mu A/\mu W/cm^2$$

Also $R_e = K S_R A$

Where I_p = Photo generated current, μA

$$E_e = \text{Irradiance, } \mu W/cm^2$$

A = Active area of the chip, cm^2

K = constant and accounts for case effects such as lensing, coating etc.

d. Light current, I_p is the current produced by the diode under a specified irradiation, E_e or illumination. E_e Typical types of radiation sources are incandescent lamps (2850K source), LEDs (typically 940 nm), mercury line source (365nm) and solar equivalent illumination (100 mW/cm²).

e. Linearity The voltage-current transfer curves are shown in Figure 11. The polarity convention used is the same as a non-light sensitive diode. Photovoltaic operation occurs in the 4th quadrant. The open circuit voltage is shown as the intersection of the transfer curve and the horizontal axis. The short circuit current is shown as the intersection of the transfer curves and the vertical axis. This is the most linear method of operation. In the 3rd quadrant, the diode is operating with reverse bias and it is apparent that the current changes only a few percent with changes in voltage. The diode can therefore be considered a constant current source. In the 1st quadrant, the diode is forward biased. Forward voltage drop for 10mA of forward current varies from 500mV to 1.2V depending on the chip size and process. Linearity is limited at the high current level by the internal series resistance. At the low current level the limitation is the dark resistance. Diodes with very high dark resistance may be operated at levels from picoamperes to milliamperes with only 1-2% linearity errors.

VOLT-AMPERE CHARACTERISTICS

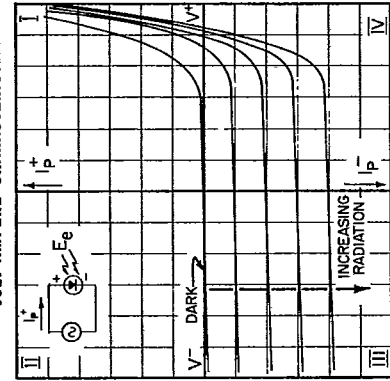


FIGURE 11

f. Dark resistance is determined by the application of a small voltage to the cell, typically 10mV and measuring the current. This parameter is voltage sensitive but is useful in calculating the offset gain ($G_{off} = 1 + R_p/R_D$) in transimpedance amplifier circuits.

g. Dark current is measured with a reverse voltage applied to the cell. This voltage may be as low as 100mV or as high as 50V and the dark current may vary from pA to μA depending upon the chip size and process. It changes very little with reverse voltage but diodes should not be operated at any voltage higher than the dark test voltage or the breakdown voltage if it is stated as a minimum.

h. Breakdown voltage is determined by the process but is a screened parameter. Diodes normally intended for photovoltaic operation do not have this parameter specified.

i. Open circuit voltage has a logarithmic characteristic, limited at low illumination levels by the dark resistance. Due to the high temperature coefficient, this characteristic is difficult to use since it requires careful compensation.

j. Response time of a diode depends upon the wavelength of the radiation, applied voltage, junction capacitance and load resistance. Characteristic curves given with each process show that the non-saturated response time is largely dependent upon the product of the junction capacitance and load resistance. However, when this product is small, other effects become significant and limit the response time. Long wavelength radiation is absorbed below the depletion region and carriers diffusion is absorbed below the depletion region and carriers diffuse slowly since there is little accelerating potential. When carrier lifetime is high, this component will be a significant portion of the photocurrent causing the response time to deviate from a single exponential curve. Increasing the bias voltage widens the depletion region so that more carriers are generated there. At 940nm, the 90% absorption depth is 1.15 micrometers. The VTP diodes require 50V to achieve this depletion width. For fastest response, use shorter wavelength sources. Request NOTE 82M62 for a more detailed discussion.

k. Temperature affects the spectral response as well as the dark resistance and current. Typical temperature variation of spectral sensitivity characteristics are shown for each process. The primary source of this variation is the change in absorption coefficient with temperature. In effect, this causes a shift in the absolute spectral response to the longer wavelengths.

l. Noise in diodes is generated by random fluctuations of carriers. In measurement and control applications, the major concern is flicker and "popcorn" noise. When the signal level is low, noise bursts can be a problem. Noise currents on the VTB and VTP process diodes are in the range of 10-10⁻¹⁴ A/Hz. Noise currents on the VTS1, 2 and 3 process are slightly higher. Request NOTE 82M63 for more detailed discussion.